		SIPE	_			
FC	ORM PTO-1595 RESORDATION FORM COVE 1-31-92 PATENTS ONLY		•	4-10-20	01	
<u>}</u>	19.11.00	C 1 1 2000				100 52
	Honorable Commissioner of Patents and Trademarks: record the attached original documents or copy thereof.	کې	ý 1	0165862	20	
1. 40		2.	Name and addr			
3 2001	Name of conveying party(ies): Sun Nakauchi Samu Kawai ORIGN	Name:	Mitsubishi R	ayon Co., Ltd.		
Addition	name(s) of conveying party(ies) attached? Yes No	Internal A		9, Kyobashi 2-c kyo 104 Japan	home, Chuo-Ki	٦,
HADE	Nature of conveyance:	Street Ad	ldress: 3-1	9, Kyobashi 2-c	home	-
	Assignment Merger	City:	Chuo-Ku, Tokyo)		
	Security Change of Name Agreement	State:	Japan	Zip Code:	104	
	Other: [Describe]	Additiona	al name(s) & Add	dress(es) attach	ned?	
Execution	on Date:		☐ Yes	⊠ No		
4.	Application number(s) or patent number(s): If this document is b	eina filed to	gether with a ne	ew application, t	he execution d	ate o
	the application:	Ü		, ,		
A.	Patent Application Number(s):	В.	Patent Number((s):		
	08/981,041					
	Additional numbers attached?	 ☐ Yes	⊠ No			
5.	Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and registrations involved: [number]				
Name:	Finnegan, Henderson, Farabow, Garrett & Dunner, L.L.P.	7. Total fee (37 CFR 3.41): 9		R 3.41): \$40		
	1300 I Street, N.W. Washington, D.C. 20005-3315		Enclosed (Please charge deficiency to depaccount)		posit	
			ŕ	I to be charged	to deposit acco	unt
Internal	Address: FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER, L.L.P.			C	•	
Street A	Address: 1300 I Street, N.W.					
City:	Washington, D.C.					
State:	Zip: 20005-3315	8.	Deposit Accoun	nt No.: <u>06-0916</u>		
	Statement and signature.					
9.		and correc	t and anv attach	ed copy is a tru	e copy of the o	rigina
	best of my knowledge and belief, the foregoing information is true ent.	and conec	,			
To the b	ent.			11 Dec	2.00	
To the b	· ·			11 Dec	<u> </u>	

2/21/2000 DNGUYEN 00000502 08981041

40.00

40.00 D

PATENT REEL: 011651 FRAME: 0265

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

MOLDED RESIN ARTICLES HIVING MARPROOF ORGANIC HARD COAT LAYER AND NONFOGGING ORGANIC HARD

(Title of Invention)

COAT LAYER, PROCESS FOR THE PRODUCTION OF THE SAME, AND COATING MATERIALS THEREFOR	
for which I/We executed an application for United States Letters Patent concurrently herewith or filed an application for	
United States Letters Patent on, 19(Serial No	_); and
WHEREAS, Mitsubishi Rayon Co., Ltd.	
(Full Name of Assignee)	
a corporation of	
(Country of Incorporation)	
whose post office address is 3-19, Kyobashi 2-chome, Chuo-ku, Tokyo 104 Japan	
(hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention	n, the

(hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/We, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, my/our entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/We hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with assignee, its successors and assigns, any facts known to me/us respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

IN TESTIMONY WHEREOF, I/We have hereunto set our hand(s).

1. FULL NAME OF SOLE OR FIRST ASSIGNOR	ASSIGNOR'S SIGNATURE		DATE
Jun Nakauchi	Jun Nakaticher		
ADDRESS c/o Otake Plants, Mitsubishi 20-1, Miyuki-cho, Otake-shi,	Rayon Co., Ltd.	CITIZENSHIP	
20-1, Miyuki-cho, Otake-shi,	Hfroshima 739-06 Japan	n Jaj	pan
2. FULL NAME OF SECOND ASSIGNOR, IF ANY	ASSIGNOR'S SIGNATURE		DATE
Osamu Kawai	Osamu Kawai		
ADDRESS C/O Otake Plants, Mitsubishi 20-1, Miyuki-cho, Otake-shi,	Rayon Co., Ltd.	CITIZENSHIP	
20-1, Miyuki-cho, Otake-shi,	Hiroshima 739-06 Japan	ı Jaj	pan
3. FULL NAME OF THIRD ASSIGNOR, IF ANY	ASSIGNOR'S SIGNATURE		DATE
ADDRESS		CITIZENSHIP	
4. FULL NAME OF FOURTH ASSIGNOR, IF ANY	ASSIGNOR'S SIGNATURE		DATE
ADDRESS		CITIZENSHIP	
5. FULL NAME OF FIFTH ASSIGNOR, IF ANY	ASSIGNOR'S SIGNATURE		DATE
ADDRESS		CITIZENSHIP	
6. FULL NAME OF SIXTH ASSIGNOR, IF ANY	ASSIGNOR'S SIGNATURE		DATE
ADDRESS		CITIZENSHIP	

FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER • WASHINGTON, D.C.

FHFGD FORM 100 November 86

PATENT REEL: 011651 FRAME: 0266

RECORDED: 12/11/2000